| Ref # | Hits | Search Query | DBs | Default Operator | Plurais | Time Stamp |
|----------|------|---|---|---------------------|---------|-------------------------------|
| L3 | 2007 | (257/637 or 257/642 or 257/734). ccls. | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/04/03 22:26 |
| L1 | 1877 | (257/637 or 257/742 or 257/734). ccls. | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/04/03 22:26 |
| S9 | 34 | semiconductor and (organic near7 polybenzoxazole) and (dielectric and insulat\$3) and @ad<"20021203" | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/04/03 22:27 |
| S8 | 788 | semiconductor and (organic near10 (dielectric and insulat\$3)) and @ad<"20021203" and (bond or pad) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/04/03 22:27 |
| S7 | 1688 | semiconductor and (organic near10 (dielectric and insulat\$3)) and @ad<"20021203" | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/04/03 22:27 |
| S5 | 616 | semiconductor and hall and organic and (dielectric and insulat\$3) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/04/03 22:27 |
| L4 | 729 | semiconductor and hall and organic and (dielectric and insulat\$4) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/04/03 22:27 |
| L9 | 172 | semiconductor and (organic with polybenzoxazole) and (dielectric or insulat\$3) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | ⁻ 2005/04/03 22:28 |
| L8 | 114 | semiconductor and (organic with polybenzoxazole) and (dielectric and insulat\$3) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/04/03 22:28 |
| L7 | 79 | semiconductor and (organic with polybenzoxazole) and (dielectric and insulat\$3) and @ad<"20021203" | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/04/03 22:28 |
| L6 | 1226 | semiconductor and (organic near10 (dielectric and insulat\$3)) and (bond or pad) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/04/03 22:28 |
| L12 | 1134 | semiconductor and (organic near10 (dielectric or insulat\$3)) and (bond or pad or wiring) and seed\$4 | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/04/03 22:29 |

| L11 | 18666 | semiconductor and (organic near10 (dielectric or insulat\$3)) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/04/03 22:29 |
|-----|-------|--|---|----|----|------------------|
| L10 | 7685 | semiconductor and (organic near10 (dielectric or insulat\$3)) and (bond or pad) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/04/03 22:29 |
| L5 | 2526 | semiconductor and (organic near10 (dielectric and insulat\$3)) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/04/03 22:29 |
| L14 | 377 | semiconductor and (organic near10 (dielectric or insulat\$3)) and ((bond or pad or wiring) same seed\$4) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/04/03 22:31 |
| L13 | 201 | semiconductor and (organic near10 (dielectric or insulat\$3)) and ((bond or pad or wiring) with seed\$4) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/04/03 22:31 |
| L2 | 1467 | (257/753 or 257/759 or 257/760). ccls. | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/04/03 22:55 |
| L16 | 1807 | semiconductor and (seed\$5 same (bond\$4 or pad)). | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/04/03 23:04 |
| L18 | 785 | semiconductor and (seed\$5 with (bond\$4 or pad)) and (insulat\$5 or dielectric) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/04/03 23:05 |
| L17 | 1494 | semiconductor and (seed\$5 same (bond\$4 or pad)) and (insulat\$5 or dielectric) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/04/03 23:05 |
| L19 | 280 | semiconductor and ((seed\$5 with (bond\$4 or pad)) same (insulat\$5 or dielectric)) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/04/03 23:48 |
| L15 | 50 | (257/753 or 257/759 or 257/760 or 257/637 or 257/642 or 257/734).ccls. and (seed\$5 same (bond\$4 or pad)) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/04/03 23:48 |
| L21 | 817 | (257/753 or 257/759 or 257/760 or 257/637 or 257/642 or 257/734).ccls. and ((bond\$4 or pad) same (insulat\$4 or dielectric)) and @ad<"20021230" | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/04/03 23:49 |

| ו | .20 | 971 | (257/753 or 257/759 or 257/760 or 257/637 or 257/642 or 257/734).ccls. and ((bond\$4 or pad) same (insulat\$4 or | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/04/03 23:49 |
|---|-----|-----|--|---|----|----|------------------|
| | | | pad) same (insulat\$4 or dielectric)) | DERWENT | | | |